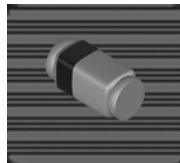


**LS4150**

Fast Switching Diode

**Features**

- ♦ Silicon Epitaxial Planar Diode
- ♦ Electrical data identical with the device 1N4150
- ♦ Quadro Melf package

**Applications**

- ♦ High speed switch and general purpose use in computer and industrial applications

**Mechanical Data**

- ♦ Case:QuadroMELF Glass Case (SOD-80)
- ♦ Weight: approx. 34 mg
- ♦ Cathode Band Color: Black

**■Absolute Maximum Ratings**(  $T_{amb}=25^{\circ}C$  unless otherwise specified )

Parameter	Test Condition	Symbol	Value	Unit
Repetitive peak reverse voltage		$V_{RRM}$	50	V
Reverse voltage		$V_R$	50	V
Peak forward surge current	$t_p = 1 \mu s$	$I_{FSM}$	4	A
Forward current		$I_F$	600	mA
Average forward current	$V_R = 0$	$I_{FAV}$	300	mA
Power dissipation		$P_V$	500	mW

**■Thermal Characteristics**(  $T_{amb}=25^{\circ}C$  unless otherwise specified )

Parameter	Test Condition	Symbol	Value	Unit
Junction ambient	on PC board 50 mm X 50mm X 1.6mm	$R_{thJA}$	500	K/W
Junction temperature		$T_J$	175	°C
Storage temperature range		$T_{sg}$	-65 to +175	°C

**■Electrical Characteristics**(  $T_{amb}=25^{\circ}C$  unless otherwise specified )

Parameter	Test Condition	Symbol	Min.	Typ.	Max.	Unit
Forward voltage	$I_F=1mA$	$V_F$	0.54		0.62	V
	$I_F=10mA$		0.66		0.74	
	$I_F=50mA$		0.76		0.86	
	$I_F=100mA$		0.82		0.92	
	$I_F=200mA$		0.87		1.0	
Reverse current	$V_R=50V$	$I_R$			100	nA
	$V_R=50V, T=150^{\circ}C$				100	
Diode capacitance	$V_R=0, f=1MHz, V_{HF}=50mV$	$C_D$			2.5	pF
Reverse recovery time	$I_R=I_R=10 \text{ to } 100mA, I_R=0.1 \times I_R, R_L=100\Omega$	$t_{rr}$			4	nS

## ■Typical characteristics

(  $T_{amb}=25^{\circ}\text{C}$  unless otherwise specified )

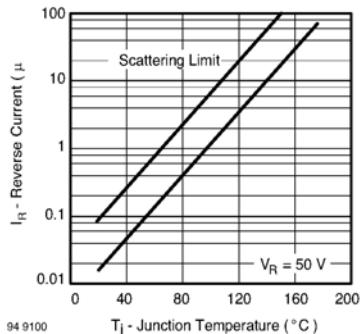


Fig. 1 Reverse Current vs. Junction Temperature

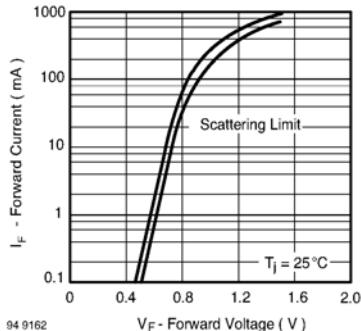
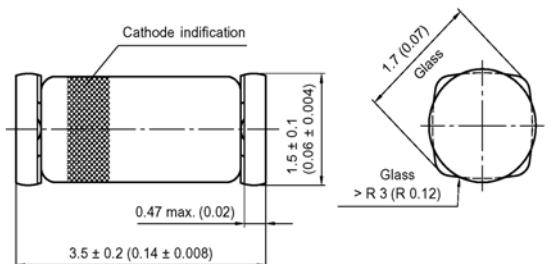


Fig. 2 Forward Current vs. Forward Voltage

## Package Dimensions in mm (inches)



### Mounting Pad Layout

